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Orderable: ISO5852SDWEVM-017	Designed for: Public Release	Mod. Date: 3/29/2018
TID #: N/A	Project Title: Module Driver ISO5852SDWEVM-017	
Number: HVP017	Rev: A	Sheet Title: Full Schematic
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By: Rais Miftakhutdinov	File: HVP017A_Schematic.SchDoc	Size: B
Engineer: Rais Miftakhutdinov	Contact: http://www.ti.com/support	

DNP

FID1

DNP

FID2

DNP

FID3

PCB Number: HVP017

PCB Rev: A



Logo1

PCB

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Logo4

PCB

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WEEE logo

Logo5

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FCC disclaimer

ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Orderable: ISO5852SDWEVM-017		Designed for: Public Release		Mod. Date: 3/27/2018	
TID #: N/A		Project Title: Module Driver ISO5852SDWEVM-017			
Number: HVP017		Rev: A	Sheet Title: Hardware		
SVN Rev: Version control disabled		Assembly Variant: 001			Sheet: 2 of 2
Drawn By: Rais Miftakhutdinov		File: HVP017A_Hardware.SchDoc			Size: B
Engineer: Rais Miftakhutdinov		Contact: http://www.ti.com/support			